

## PRODUCT/PROCESS CHANGE NOTICE (PCN)

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PCN #:	CN #: <b>F0301-02</b> DA'		4/2/2003	MEANS OF DISTI	NGUISHING CHANGED DEVICES:	
Product Affe	ected:			□ Product Mark		
IDT72V2103	, IDT72V2113, IDT7	2V36100, IDT72	V36110	Back Mark	Please see Des	cription section below
IDT72V295,	IDT72V2105, IDT72	V2101, IDT72V2	2111	Date Code	for details	
Date Effectiv	ve: 7/2/2003			□ Other		
Contact:	Dasharath Patel					
Title:	Quality Assurance I	Manager		Attachment::	Yes	No No
Phone #:	(408) 330-1488					
Fax #:	(408) 330-1450			Samples: Avai	ilable now	
E-mail:	Dasharath.Patel@	lidt.com				
DESCRIPT	ON AND PURPOSI	E OF CHANGE:				
Die Tech				nrink and process char	nge from CEMOS	8 to CEMOS 11.5
Wafer Fa	brication Process					
□ Assembly				s of identifying mater		
Equipment	nt		CEM	1	Date Code:	
			CEM	OS 11.5: X-Step	Date Code:	XByyww
□ Testing □ Manufact	uring Site					yy: Year
Data She	-					ww: Work Week
$\Box$ Other						ww. work week
IDT records to grant app it will be as IDT reserve	<b>R ACKNOWLEDG</b> indicate that you required and its additional or request additional or request additional that this changes the right to ship either version has been de	uire written notifi onal information e is acceptable. er version manufa	cation of this of this of the second se	not receive acknowled	lgement within 30	days of this notice
Customer:				] Approval for	shipments pri	or to effective date.
Name/Date:			E-	Mail Address:		
Title:			Pł	none# /Fax# :		
CUSTOME	R COMMENTS:					
IDT ACKN	OWLEDGMENT O	F RECEIPT:				
RECD. BY:				DATE:		
IDT FRA-15	509-01 REV. 00 09/1	8/01	Page	1 of 3		Refer To QCA-1795



Integrated Device Technology, Inc. 2975 Stender Way, Santa Clara, CA - 95054

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### ATTACHMENT - PCN #: F0301-02

PCN Type:	Die Shrink and Process Change
Data Sheet Change:	None
Detail of Change:	Die shrink and process technology change (CEMOS 8 to CEMOS 11.5) for the following products:
	IDT72V2103, IDT72V2113, IDT72V36100, IDT72V36110 IDT72V295, IDT72V2105, IDT72V2101, IDT72V2111

**Conversion Schedule (Estimated)** 

Samples

Available upon request

7/2/2003

Production Shipments



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#### ATTACHMENT - PCN #: F0301-02

Qualification Plan: QFI-02-17

Test Vehicle:

IDT72V36110

Test Description/Condition	Test Methods	SS /# Fails	Test Results
Highly Accelerated Stress Test (HAST) (100 Hrs, @130°C/85%RH,Static Bias)	EIA/JESD22-A110	45/0	45 / 0
Temperature Cycling (-65°C to +150°C, 500 cyc)	MIL-STD-883, Method 1010	45/0	45 / 0
Auto Clave (SPP) (168Hrs, @ 2ATM, 121°C)	EIA/JESD22-A102	45/0	45 / 0
Life Test (+125°C, 1000 hrs)	MIL-STD-883, Method 1005	77/0	77 / 0
Latch-Up Immunity (+ - I and V stress, + - 100mA Trigger)	EIA/JESD 78	10/0	10 / 0
ESD Human Body Model	MIL-STD-883, Method 3015	9/0	9/0
ESD Charge Device Model	JESD22-C101	6/0	6 / 0

#### Characterization Data:

Characterization Data is available upon request.